onsemi

MOSFET – N-Channel, POWERTRENCH[®]

80 V, 80 A, 4.5 mΩ

FDMS86368-F085

Features

- Typical $R_{DS(on)} = 3.7 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 57 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems

Symbol	Parameter	Ratings	Unit				
V _{DSS}	Drain to Source Voltage	80	V				
V _{GS}	Gate to Source Voltage	±20	V				
۱ _D	Drain Current ($T_C = 25^{\circ}C$) Continuous ($V_{GS} = 10$ V) (Note 1) Pulsed	80 (see Fig. 124)	A				
E _{AS}	Single Pulse Avalanche Energy (Note 2)	82	mJ				
PD	Power Dissipation Derate above 25°C	214 1.43	W W/°C				
T _J , T _{STG}	Operating and Storage Temperature	–55 to +175	°C				
$R_{ extsf{ heta}JC}$	Thermal Resistance (Junction to case)	0.7	°C/W				
$R_{ heta JA}$	Maximum Thermal Resistance (Junction to Ambient) (Note 3)	50	°C/W				

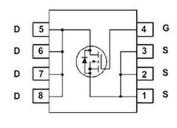
MOSFET MAXIMUM RATINGS (T_{.1} = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by bondwire configuration.
- 2. Starting $T_J = 25^{\circ}$ C, $\dot{L} = 40 \,\mu$ H, $I_{AS} = 64$ A, $V_{DD} = 80$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	4.5 m Ω @ 10 V	80 A

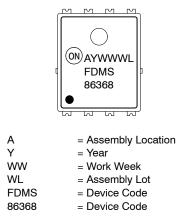
ELECTRICAL CONNECTION



N-Channel MOSFET



MARKING DIAGRAM



(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
FDMS86368-F085	DFNW8 (Power56) (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units		
OFF CHAR	OFF CHARACTERISTICS							
B _{VDSS}	Drain-to-Source Breakdown Voltage	I_D = 250 μ A, V_{GS} = 0 V	80			V		
I _{DSS}	Drain-to-Source Leakage	$V_{DS} = 80$ V, $V_{GS} = 0$ V, $T_J = 25^{\circ}C$			1	μΑ		
	Current	V_{DS} = 80 V, V_{GS} = 0 V, T_{J} = 175 $^{\rm o}C$ (Note 4)			1	mA		
I _{GSS}	Gate-to-Source Leakage Current	V_{GS} = ±20 V			±100	nA		

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	V_{GS} = V_{DS} , I_D = 250 μ A	2.0	3.0	4.0	V
R _{DS(on)}	Drain to Source On Resistance	I_D = 80 A, V_{GS} = 10 V, T_J = 25°C		3.7	4.5	mΩ
		I_D = 80 A, V_{GS} = 10 V, T_J = 175°C (Note 4)		7.4	9.0	

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 40 V, V_{GS} = 0 V, f = 1 MHz		4350		pF
C _{oss}	Output Capacitance			636		
C _{rss}	Reverse Transfer Capacitance	1		20		
Rg	Gate Resistance	f = 1 MHz		2.5		Ω
Q _{g(ToT)}	Total Gate Charge	V_{GS} = 0 V to 10 V	$V_{DD} = 64 \text{ V}, \text{ I}_{D} = 80 \text{ A}$	57	75	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 V to 2 V		8		
Q _{gs}	Gate-to-Source Gate Charge		-	23		
Q _{gd}	Gate-to-Drain "Miller" Charge			11		

SWITCHING CHARACTERISTICS

t _{on}	Turn–On Time	V_{DD} = 40 V, I_{D} = 80 A, V_{GS} = 10V, R_{GEN} = 6 Ω		60	ns
t _{d(on)}	Turn-On Delay		23		
t _r	Rise Time		22		
t _{d(off)}	Turn-Off Delay		32		
t _f	Fall Time		13		
t _{off}	Turn-Off Time			59	

DRAIN-SOURCE DIODE CHARACTERISTICS

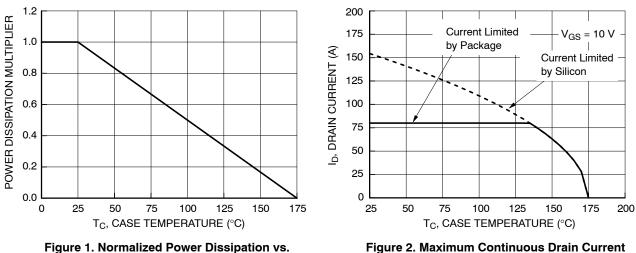
V _{SD}	Source-to-Drain Diode Voltage	$I_{SD} = 80 \text{ A}, V_{GS} = 0 \text{ V}$ $I_{SD} = 40 \text{ A}, V_{GS} = 0 \text{ V}$		1.25 1.2	V
t rr	Reverse-Recovery Time	I_{F} = 80 A, $\Delta I_{SD}/\Delta t$ = 100 A/µs, V_{DD} = 64 V	58	75	ns
Q _{rr}	Reverse-Recovery Charge		49	67	nC

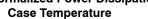
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTE:

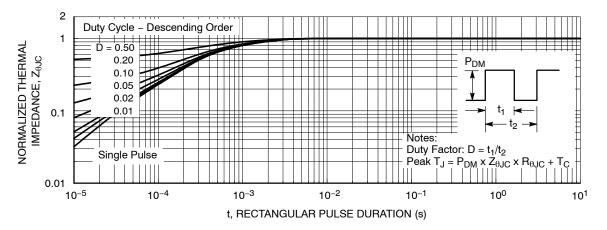
4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS











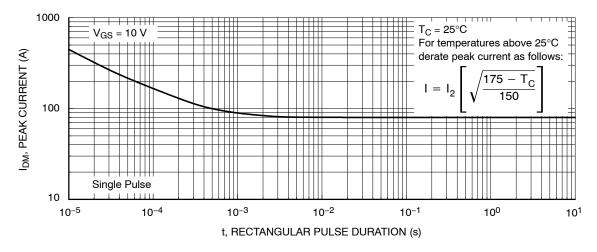
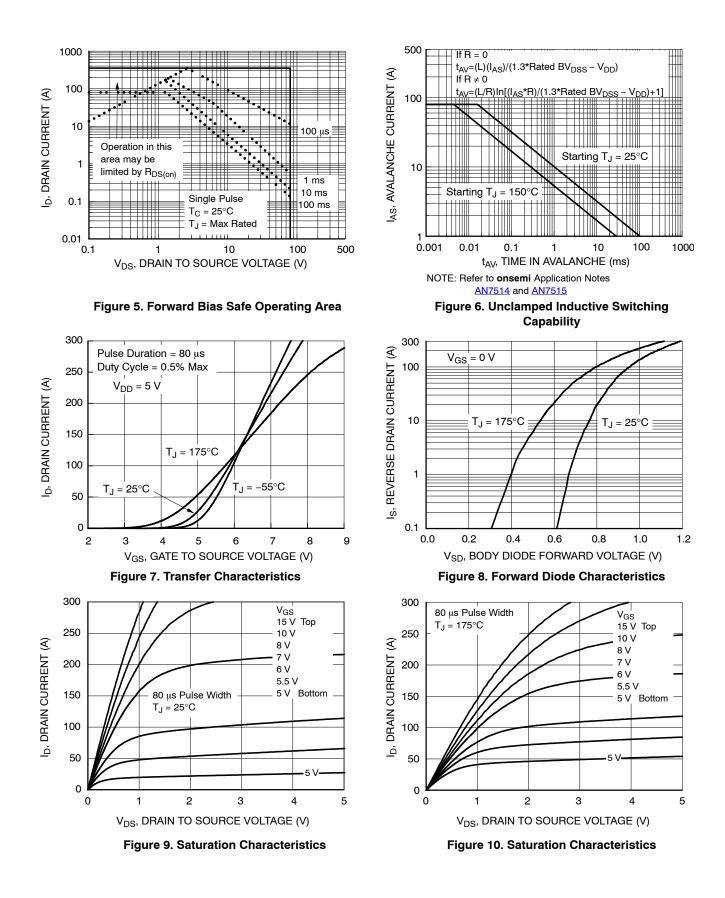
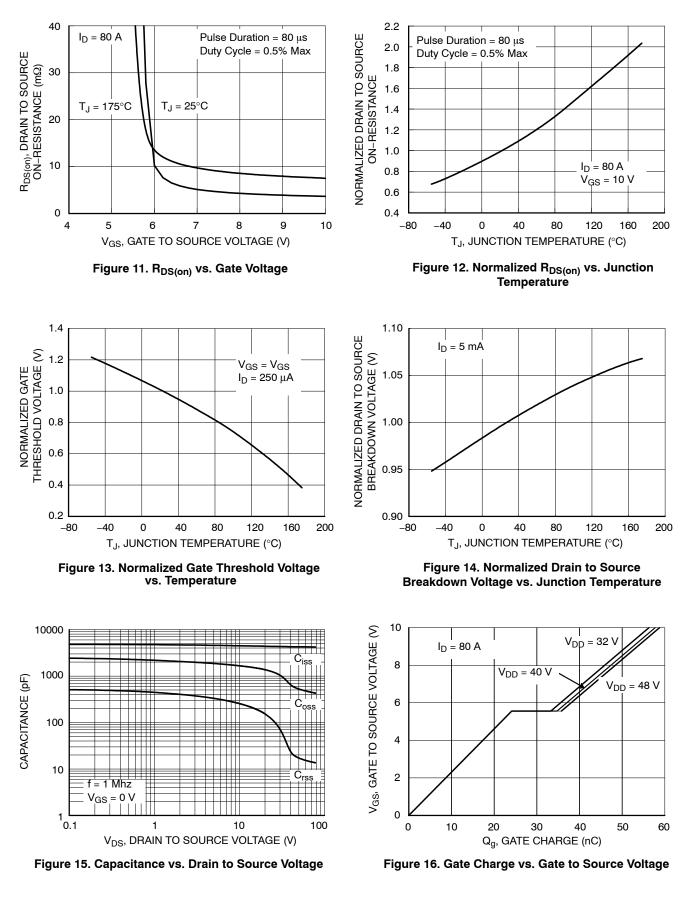


Figure 4. Peak Current Capability

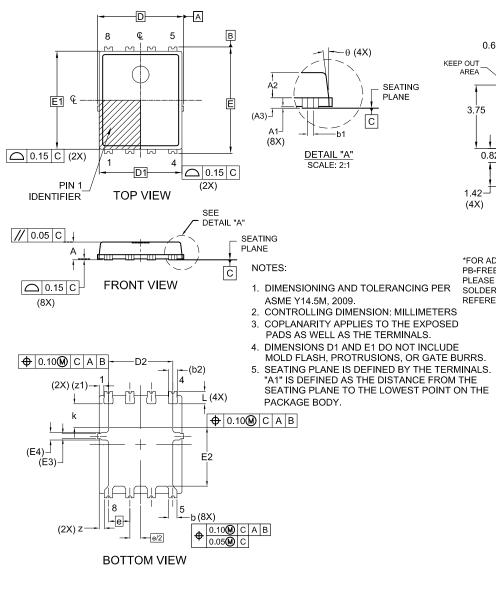
TYPICAL CHARACTERISTICS

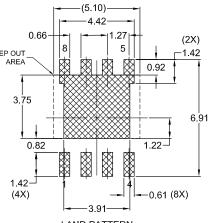




PACKAGE DIMENSIONS

DFNW8 5.2x6.3, 1.27P CASE 507AU ISSUE A





LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

DIM	N	IILLIMET	ERS	
Dim	MIN.	NOM.	MAX.	
A	0.90	1.00	1.10	
A1	-	-	0.05	
A2	0.65	0.75	0.85	
A3	(0.30 REF		
b	0.47	0.52	0.57	
b1	0.13	0.18	0.23	
b2		(0.54)		
D	5.00	5.10	5.20	
D1	4.80	4.90	5.00	
D2	3.72	3.82	3.92	
E	6.20	6.30	6.40	
E1	5.70	5.80	5.90	
E2	3.38	3.48	3.58	
E3		0.30 REF		
E4	(0.45 REF		
е	1	1.27 BSC	;	
e/2	(0.635BS	0	
k	1.30	1.40	1.50	
L	0.64	0.74	0.84	
z	0.24	0.29	0.34	
z1	(0.28)			
θ	0°		12°	

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